

Pb RoHS

#### **General Description**

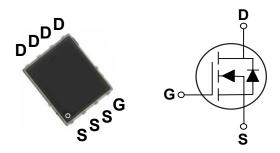
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	Ι <sub>D</sub>
60 V	2 mΩ	140 A

#### Features

- $R_{DS(ON)} \leq 2m\Omega @V_{GS} = 10V$
- Fast Switching
- Improved dv/dt Capability
- Green Device Available

#### PPAK5X6 Pin Configuration



#### **Applications**

- Networking
- Load Switch
- LED Applications

Absolute Maximum Ratings T <sub>c</sub> =25°C unless otherwise noted						
Symbol	Parameter	Rating	Units			
V <sub>DS</sub>	Drain-Source Voltage	60	V			
V <sub>GS</sub>	Gate-Source Voltage	±20	V			
۱ <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> =25°C)	140	А			
I <sub>DM</sub>	Drain Current - Pulsed (NOTE 1)	560	А			
EAS	Single Pulse Avalanche Energy (NOTE 2)	423	mJ			
IAS	Single Pulse Avalanche Current (NOTE 2)	92	А			
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> =25°C)	110	W			
TJ	Operating Junction Temperature Range	-55 to 150	°C			
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C			
Marking Code		NG2P0				

#### **Thermal Characteristics**

Symbol	Parameter		Max.	Unit	
R <sub>θJA</sub>	Thermal Resistance Junction to Ambient		62	°C/W	
$R_{ ext{ ext{ ext{ ext{ ext{ ext{ ext{ ext$	Thermal Resistance Junction to Case		1.13	°C/W	





#### Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

Off Characteristics						
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	60			V
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{DS}$ =60V , $V_{GS}$ =0V , $T_{J}$ =25°C			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V			±100	nA

#### **On Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V , I <sub>D</sub> =20A			2	mΩ
		V <sub>GS</sub> =4.5V , I <sub>D</sub> =10A			3.2	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_{D}=250$ uA	1.2		2.5	V
gfs	Forward Transconductance	V <sub>DS</sub> =10V , I <sub>D</sub> =3A		15		S

#### **Dynamic and switching Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$Q_g$	Total Gate Charge			98		
$Q_gs$	Gate-Source Charge	V <sub>DS</sub> =30V , V <sub>GS</sub> =10V , I <sub>D</sub> =50A (NOTE 3 ∖ 4)		24		nC
$Q_{gd}$	Gate-Drain Charge	(NOTE 3 · 4)		27		
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =30V , V <sub>GS</sub> =10V , R <sub>G</sub> =3.3Ω , I <sub>D</sub> =1A (NOTE 3 \ 4)		19		
Tr	Rise Time			12		nS
T <sub>d(off)</sub>	Turn-Off Delay Time			62		115
T <sub>f</sub>	Fall Time			130		
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =30V , V <sub>GS</sub> =0V , F=1MHz		4947		
C <sub>oss</sub>	Output Capacitance			2850		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			26		
$R_{g}$	Gate resistance	$V_{GS}$ =0V , $V_{DS}$ =0V , F=1MHz		1.1		Ω

#### **Drain-Source Diode Characteristics and Ratings**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
۱ <sub>s</sub>	Continuous Source Current	$V_{G}=V_{D}=0V$ , Force Current			140	А
I <sub>SM</sub>	Pulsed Source Current				280	А
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C			1	V

NOTES :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.

2.  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH, I<sub>AS</sub>=92A, R<sub>G</sub>=25 $\Omega$ , Starting T<sub>J</sub>=25 $^{\circ}$ C.

3. The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%.

4. Essentially independent of operating temperature.



#### **Characteristics Curves**

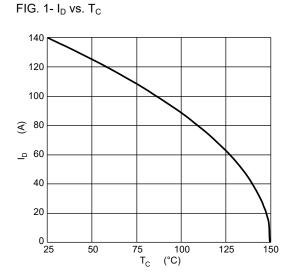


FIG. 3- Normalized  $V_{GS(th)}\,vs.\;T_J$ 

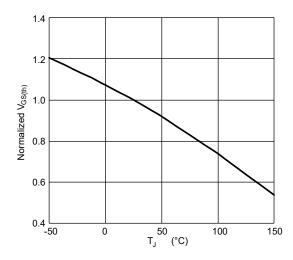


FIG. 5- Normalized Transient Impedance

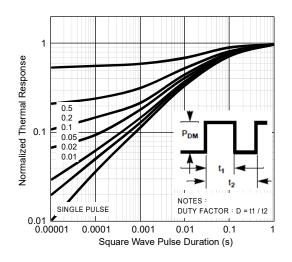


FIG. 2- Normalized  $R_{DS(ON)}$  vs.  $T_J$ 

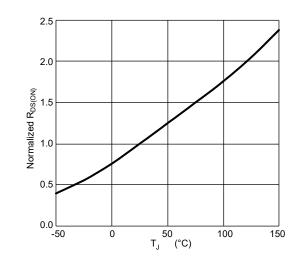


FIG. 4-Gate Charge Characteristics

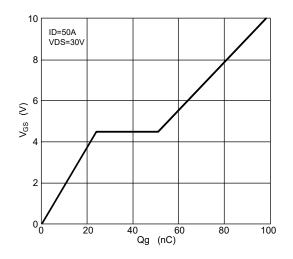
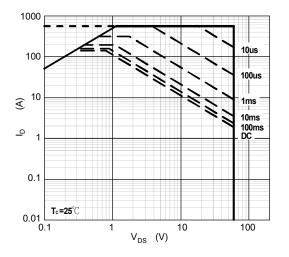


FIG. 6-Safe Operation Area







#### **Characteristics Curves**

FIG. 7- Switching Time Waveform

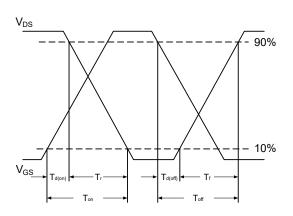
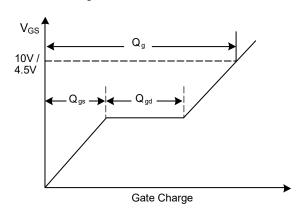
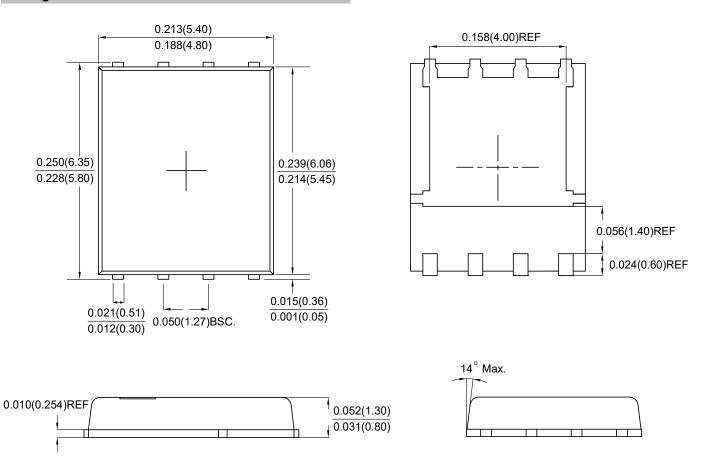


FIG. 8- Gate Charge Waveform



#### **Package Outline Dimensions**



**PPAK5X6** Dimensions in inches and (millimeters)

DC-01441 4 / 5



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